## BGY835C

# CATV amplifier module Rev. 2 — 28 September 2010

Product data sheet

#### 1. **Product profile**

## 1.1 General description

Hybrid high dynamic range amplifier module operating at a supply voltage of 24 V (DC) in an SOT115J package. The module consists of two cascaded stages both in cascode configuration.

#### **CAUTION**



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

### 1.2 Features and benefits

- Excellent linearity
- Extremely low noise
- High gain
- Excellent return loss properties

## 1.3 Applications

Single module line extender in CATV systems operating in the 40 MHz to 860 MHz frequency range.

#### 1.4 Quick reference data

Table 1. Quick reference data

Bandwidth 40 MHz to 860 MHz;  $V_B = 24$  V;  $T_{mb} = 30$  °C;  $Z_S = Z_L = 75$   $\Omega$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gp	power gain	f = 50 MHz	33.5	-	34.5	dB
		f = 860 MHz	34	-	-	dB
I <sub>tot</sub>	total current		[1] -	-	340	mA

<sup>[1]</sup> The module normally operates at  $V_B = 24 \text{ V}$ , but is able to withstand supply transients up to 30 V.



## 2. Pinning information

Table 2. Pinning

	3	
Pin	Description	Simplified outline Graphic Symbol
1	input	
2	common	1 3 5 7 9
3	common	
5	+V <sub>B</sub>	2378
7	common	sym095
8	common	·
9	output	

## 3. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
BGY835C	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; $2 \times 6-32$ UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads	SOT115J		

## 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_B$	supply voltage		-	25	V
Vi	input voltage		-	55	dBmV
T <sub>stg</sub>	storage temperature		-40	+100	°C
T <sub>mb</sub>	mounting base temperature		-20	+100	°C

## 5. Characteristics

Table 5. Characteristics

Bandwidth 40 MHz to 860 MHz;  $V_B = 24$  V;  $T_{mb} = 30$  °C;  $Z_S = Z_L = 75$   $\Omega$  unless otherwise specified.

	, 2 ,	, • -	•				
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Gp	power gain	f = 50 MHz		33.5	-	34.5	dB
		f = 860 MHz		34	-	-	dB
SL	slope cable equivalent	f = 40 MHz to 860 MHz		0.5	-	2.5	dB
FL	flatness of frequency response	f = 40 MHz to 860 MHz		-0.5	-	+0.5	dB
RLin	input return loss	f = 40 MHz to 80 MHz		20	-	-	dB
		f = 80 MHz to 160 MHz		18.5	-	-	dB
		f = 160 MHz to 320 MHz		17	-	-	dB
		f = 320 MHz to 640 MHz		15.5	-	-	dB
		f = 640 MHz to 860 MHz		14	-	-	dB
RL <sub>out</sub>	output return loss	f = 40 MHz to 80 MHz		20	-	-	dB
		f = 80 MHz to 160 MHz		18.5	-	-	dB
		f = 160 MHz to 320 MHz		17	-	-	dB
		f = 320 MHz to 640 MHz		15.5	-	-	dB
		f = 640 MHz to 860 MHz		14	-	-	dB
Ψs21	phase response	f = 50 MHz		135	-	225	deg
СТВ	composite triple beat	measured at f = 859.25 MHz	[1]	-	-	-60	dB
CSO	composite second-order distortion	measured at f = 860.5 MHz	[1]	-	-	-55	dB
NF	noise figure	f = 50 MHz		-	-	4.5	dB
		f = 860 MHz		-	-	7	dB
I <sub>tot</sub>	total current		[2]	-	-	340	mΑ

<sup>[1] 49</sup> channels;  $V_0 = 44$  dBmV, flat output level.

<sup>[2]</sup> The module normally operates at  $V_B = 24 \text{ V}$ , but is able to withstand supply transients up to 30 V.

## 6. Package outline

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads

SOT115J

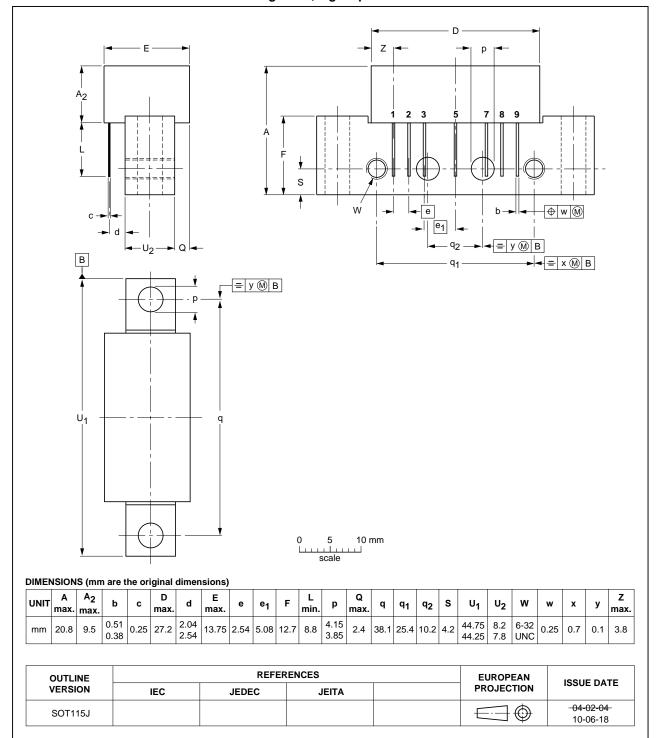


Fig 1. Package outline SOT115J

BGY835C

**CATV** amplifier module

## 7. Abbreviations

Table 6. Abbreviations

Acronym	Description
CATV	Community Antenna TeleVision
DC	Direct Current
UNC	UNified Coarse

## 8. Revision history

## Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BGY835C v.2	20100928	Product data sheet	-	BGY835C v.1
Modifications:	•	ıtline drawings have beer have been updated.	updated to the latest	version.
BGY835C v.1	20080908	Product data sheet	-	-

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#### 9.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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